SPUJ PRODUCT SPECIFICATIONS SPUJ-S-501 S

- 1. General
- 1.1 Application This specification is applied to low current circuit (Secondary circuit) push switch used for electronic equipment.
- 1.2 Operating temperature range : -10 ~ 60℃
- 1.3 Test conditions The standard test conditions shall be 5~35°C in temperature, 45~85% RH and 86~106kPa (860~1060mbar) in atmospheric pressure. Should any doubt arise in judgement, tests shall be conducted at 20 $\pm2\%$, 65 $\pm5\%$ RH and .86~106kPa {860~1060mbar} .
- 2. Appearance, construction and dimensions
- 2.1 Appearance Switch shall have good finishing, and shall have no rust, crack or plating failures.
- 2.2 Construction and dimensions Per individual product drawing
- 2.3 Markings Per individual product drawing

 3. Rating 30 V DC 0.1 A (Resistive load)

- }	ectrical performanc	Test conditions	Criterion
	Ite≖s	Test conditions	20 mΩ HAX
.1	Contact resistance		ZV #2 nn
		by voltage drop method.	100 10 10
.2	Insulation	Test voltage: 500 V DC. measured after 1 minute ±5 seconds.	100 H2 HIH
	resistance	Applied position: Between all terminals	
- 1		Between terminals and ground (frame)	
			L.,
.3	Voltage proof	Test voltage: 500 V AC (50~60Hz, cut-off current 2 mA)	No dielectric breakdown shall occur
- 1		Applied position : Between all terminals	
- 1	1,	Between terminals and ground (frame)	
4	Capacitance	Shall be measured at 1MHz ± 10kHz	1.5 pF HAX
7	Capac I cance	Between all terminals	
- 1			
	•	Between terminals and ground (frame)	
		Between all circuits	1 i-dinidual
5	Changeover timing		As per individual product drawing.
· u	chanical performanc	· •	
		Test conditions	Criterion
, 1	Items	A static load shall be applied to the tip of actuator in operating	As per individual product drawing.
1	Operating force		in poi individual produce di aville.
		direction.	St. 11 to foot for to
2	Terminal strength	A static load of 5 N (510 gf) shall be applied to the tip of	Shall be free from terminal loosen
1	•	terminal in a desired direction for 1 minute. The number of test shall	and damage and breakage of termina
1		be once per terminal.	holding portion. Terminals may be
- 1			after test, electrical performance
			requirement specified in item 4 sh
- 1			be satisfied.
-	11	Thread shall be mounted at _O.6 H·m (6.12 kgf·cm) by normal	Shall be free from damage of thread
.3	Hounting strength		portion. (Applied to frame with Scre
_	of thread portion	mounting method.	
.4	Control strength	(1) A static load of 50 N (5.1 kgf) shall be applied in the	Shall be free from pronounced wobb
ļ	5.4.1 Control	operating direction of actuator for 15 seconds.	and mechanical abnormalities.
- 1	strength	(2) A static load of 50 N (5.1 kgf) shall be applied in the	
- 1	O 5.1.g	pull direction of actuator for 15 seconds.	
1		(For construction with lock, the test shall be conducted at the	
		condition of lock released.)	
		(3) A static load of 10H (102kgf) shall be applied to the vertical	
l		direction of operation at the tip of actuator for 15 seconds.	
	5.4.2 Lock hold-	(1) A static load of 10 N (1.02 kgf) shall be applied in the pull	Lock shall not be dislocated.
	ing strength of	direction at the condition of locking actuator.	Shall be free from pronounced wobb
			and abnormalities in operation.
	actuator		
	actuator		· .
	actuator (Applied to the	·	·
	actuator (Applied to the switch with lock		
_	actuator (Applied to the switch with lock mechanism)	Durant (D.D) shall be procured by emplying a static lead of 19 [100mf]	P-P: 0.8 mm WAY
.5	actuator (Applied to the switch with lock	Run-out(P-P) shall be measured by applying a static load of 1H (102gf)	P-P: 0.8 mm MAX
	actuator (Applied to the switch with lock mechanism) Wobble of actuator	in the vertical direction of operation at the tip of actuator.	(1.8 mm MAX, without frame.)
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be	[1.8 mm MAX, without frame.] Difference between actuators
	actuator (Applied to the switch with lock mechanism) Wobble of actuator	in the vertical direction of operation at the tip of actuator.	(1.8 mm MAX, without frame.) Difference between actuators t ₁ = Vithin 0.5 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Within 0.5 mm Haximum difference of actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be	(1.8 mm MAX, without frame.) Difference between actuators t ₁ = Vithin 0.5 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin 0.5 mm Maximum difference of actuator t ₂ = Vithin 0.8 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	[1.8 mm MAX, without frame.] Difference between actuators t ₁ = Vithin <u>0.5</u> mm Maximum difference of actuator t ₂ = Vithin <u>0.8</u> mm Difference between mounting hole a actuator
5.6	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	(1.8 mm MAX, without frame.) Difference between actuators t ₁ = Vithin O.5 mm Maximum difference of actuator t ₂ = Vithin O.8 mm Difference between mounting hole a actuator t ₃ = Vithin O.5 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured.	(1.8 mm MAX, without frame.) Difference between actuators t ₁ = Vithin O.5 mm Maximum difference of actuator t ₂ = Vithin O.8 mm Difference between mounting hole a actuator t ₃ = Vithin O.5 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Svitch shall be mounted as shown. Difference of sides shall be measured. Hole for mounting frame APPP, CHKD. DSGD	[1.8 mm MAX, without frame.] Difference between actuators t1 = Vithin O.5 mm Maximum difference of actuator t2 = Vithin O.8 mm Difference between mounting hole a actuator t3 = Vithin O.5 mm
	actuator (Applied to the switch with lock mechanism) Wobble of actuator Row of actuator (Applied to multipul-key	in the vertical direction of operation at the tip of actuator. Switch shall be mounted as shown. Difference of sides shall be measured. Hole for mounting frame	(1.8 mm MAX, without frame.) Difference between actuators t ₁ = Vithin O.5 mm Maximum difference of actuator t ₂ = Vithin O.8 mm Difference between mounting hole actuator t ₃ = Vithin O.5 mm

SF	<u> PUJ-S-501</u>	SPUJ PRODUCT SPECIFICATIONS			
	Ite≖s	Test conditions	Criterion		
5.7	Hounting frame	Both ends of mounting frame shall be secured. A static load of 30H(3.06kgf) shall be applied to the center of mounting frame	Warp on mounting frame shall be 0.5mm max. Shall be free from abnormalities		
1 1	strength	in A, B, C and D directions each 15 seconds.	in operation.		
	(Applied to multi-	In A, b, c and b off eccloids each 13 seconds.			
	switch)	c ·			
	Serveny	n ↓ ∩ ∩ ∩			
		A DATE OF B			
		A .			
1 1		L 			
		D.			
1 1	-	C [']			
		Fixed Fixed			
		Fixed Fixed			
1 1	,				
		U	0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
5.8	Vibration	Switch shall be secured to a testing machine by a regular mounting	Contact resistance (Item 4.1) : 20 mQ MAX		
		device and method. (1) Vibration frequency range : 10~55Hz	Insulation resistance (Item 4.2):		
	_	(2) Total amplitude : 1.5mm	100 HO HIN		
	·	(3) Sweep ratio : 10-55-10(Hz) Approx. 1-minute	Voltage proof (Item 4.3):		
	•	(4) Hethod of changing the sweep vibration frequency: Logarithmic or	Apply <u>500</u> V AC for 1 minute. No dielectric breakdown shall occur.		
	•	linear (5) Direction of vibration: Three vertical directions	Operating force (Item 5.1):		
		including actuator.	Within $\frac{\pm 30}{30}$ % of specified value.		
		(6) Time : 2 hours each (6 hours in total)	No abnormalities shall be recognized		
			in appearance and construction.		
5.9	Hechanical shock	Syitch shall be measured after following test.	Contact resistance (Item 4.1) :		
	5.9.1 Hechanical shock	(1) Hounting method: Hormal mounting method (2) Acceleration: 490m/s² { 50G }	Operating force (Item 5.1)		
	SHOCK	(3) Duration : 11ms	Vithin $\pm \frac{10}{30}$ % of specified value.		
		(4) Test direction : 6 directions	Shall be free from mechanical		
	·		abnormalities.		
1		(5) Humber of shock: 3 times per direction (18 times in total)	(Dislocation of lock of actuator shall not be regarded as abnormalities.)		
	5.9.2 Lock holding		Lock of actuator shall not be dis-		
	shock	(1) Acceleration : 147m/s² (156)	located. Shall be free from		
	(Applied to the	(2) Duration : 11 ks	abnormalities in operation.		
	switch with lock	(3) Test direction : 6 directions			
	mechanism.)	(4) Number of shock: 3 times per direction			
1		· (18 times in total)			
5.10	Solderability	Switch shall be checked after following test.	Hore than 90% of immersed part shall		
1	·	(1) Solder: H63A (JIS Z 3282) (2) Flux: Rosin flux (JIS K 5902) having a nominal composition of 25%	be covered with solder.		
1		solids by weight of water white rosin in methyl alcohol			
		(JIS K 1501) solution.			
		(3) Soldering temperature : 230±5℃			
		Immersing time: 3±0.5 s			
		Flux immersing time shall be 5~10 seconds in normal temperature. (4) Immersion depth: Immersion depth shall be at copper plating	•		
1 .		portion for P.C.B. terminal after mounting.			
		Thickness of P.C. board : 1.6 mm			
E 11	Soldoning heat	Switch shall be measured after following test.	No abnormalities shall be recognized		
3.11	Soldering heat	(1) Solder: H63A (JIS Z 3282)	in appearance. The electrical perform-		
		(2) Flux: Rosin flux (JIS K 5902) having a nominal composition of 10%	1		
1		solids by weight of water white rosin in methyl alcohol	shall be satisfied.		
		(JIS K 1501) solution.			
		(3) Temperature and immersing time			
1		Temperature (°C) Time (s) Dip soldering 260±5 5±1			
		Dip soldering			
L					
·\		APPD. CHXD. DSGD	1 '		
1		Mr & Sun, 3	O'93 DRAWING NO.		
	·	PAGE SYHB DATE APPD CHKD DSGD to The Jordan Hillen			
<u> </u>	AIDS ELECTRIC CO	170			

C [SPUJ PRODUCT SPECIFICATIONS		Ì
<u> </u>	<u>UJ -S-501</u>	<u> </u>		
				Critoria
	Items	Test conditions (4) Immersion depth : Immersion depth shall be at copper plating		Criterion
		(4) immersion depth : immersion depth small be at copper plating portion for P.C.B. terminal after mounting.		
		Thickness of P.C. board (Single sided copper		
		clad P.C.B.) : 1.6mm		
				•
E 10	Resistance to flux	Switch shall be checked after following test.	Flux shal	l not be risen up to contact.
5.12	(Applied to the	(1) Equipment : Auto-dip chamber	Shall be	free from abnormalities in
	switch for P.C.	(2) Solder: H63A (JIS Z 3282)	operation	•
	board)	(3) Flux: Rosin flux (JIS K 5902) having a nominal composition of 25% solids by weight of water white rosin in methyl alcohol		
		(JIS K 1501) solution.		
		(4) Temperature : 260±5°C		
		(5) Immersing time: 5±1 s		
		(6) Immersion depth : Immersion depth shall be at copper plating		
		portion for P.C.B. terminal after mounting. Thickness of P.C. board: 1.6 mm		
- <u>-</u> -	1 1 1 1 4			
6. D	urability Items	Test conditions		Criterion
6.1	Operating life	Switch shall be operated 10,000 cycles at 15~20 cycles/minute without		esistance (Item 4.1) :
	without load	load.	40 =	ιΩ MAX on resistance (Item 4.2) :
			10 H	
			Voltage p	proof (Item 4.3) :
				500 V AC for 1 minute.
	·	:•	i e	ectric breakdown shall occur. force (Item 5.1):
				±30 % of specified value.
				malities shall be recognized
				ance and construction.
6.2	Operating life	Switch shall be operated 10,000 cycles at 15~20 cycles/minute with 30 V DC 0.1 A. (Resistive load)		resistance (Item 4.1) :
	with load	JO V DC O.1 A. (Resistive load)		on resistance (Item 4.2) :
				IQ HIN.
				proof (Item 4.3) : 500 V AC for 1 minute.
		,		lectric breakdown shall occur.
· ·	-	•		force (Item 5.1):
			i	±36 % of specified value.
1				malities shall be recognized rance and construction.
				ance and consultations
7.	leather proof Items	·Test conditions	Γ	Criterion
7.1	Cold proof	After testing at -20±2°C for 96 hours, the switch shall be allowed to	Contact :	resistance (Item 4.1):
		stand under normal temperature and humidity conditions for 1 hour, and		RQ HAX
		then measurement shall be made within 1 hour. Vater drops shall be removed.		on resistance (Item 4.2): NO NIN
		sace at the significanted.	Voltage	proof (Item 4.3) :
				500 V AC for 1 minute.
				lectric breakdown shall occur. g force (Item 5.1):
			Vithin	$\pm \frac{10}{30}$ % of specified value.
			No abnor	malities shall be recognized
		1	in appea	rance and construction. resistance (Item 4.1):
7.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and	40	≖Ω HAX .
		then measurement shall be made within 1 hour.	Insulati	on resistance (Item 4.2) :
				MQ HIN proof (Item 4.3):
		·	Apply	500 V AC for 1 minute.
			No die	electric breakdown shall occur.
1			Operation	ng force (Item 5.1):
		·	Vithin	$\pm \frac{\pm \frac{7}{3}}{3}$ % of specified value. The recognized
			in appea	arance and construction.
:-		APPD. CHKD. DSGD	. TITI	E
-		M & Tun.	30 93 DRAI	VING NO.
		PAGE SYMB DATE APPD CHIED DSGD & Sa Jahalan William	egadi una	(3/5)

	Items	Test conditions	Criterion Contact resistance (Item 4.1):
3	Damp heat	After testing at 40±2°C and 90~95%RH for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions	40 =Q HAX
		for 1 hour, and measurement shall be made within 1 hour after that.	Insulation resistance (Item 4.2):
- 1		Water drops shall be removed.	10 MQ MIN Voltage proof (Item 4.3):
		•	Apply 500 V AC for 1 minute.
			No dielectric breakdown shall occu
		·	Operating force (Item 5.1): Within ±30 % of specified value
			No abnormalities shall be recognized
			in appearance and construction. No remarkable corrosion shall be
4	Salt mist	Switch shall be checked after following test. (1) Temperature: 35±2°C	recognized in metal part.
		(2) Salt solution: 5±1% (Solids by weight)	
		(3) Duration: 24±1 h	
5	Temperature	After the test, salt deposit shall be removed in running water. After 5 cycles of following conditions, the switch shall be allowed to	Contact resistance (Item 4.1) :
-	cycling	stand under normal temperature and humidity conditions for 1 hour, and	40 mΩ MAX
		measurement shall be made within 1 hour after that.	Insulation resistance (Item 4.2) : _10 HΩ HIN
		Water drops shall be removed.	Voltage proof (Item 4.3):
		70±2℃	Apply <u>500</u> V AC for 1 minute.
		•	Operating force (Item 5.1):
	•		Within ±48 x of specified value
			No abnormalities shall be recognized in appearance and construction.
		Hormal temperature	The appearance and construction.
	:		
	·	-25±3℃ 30 L	
		min min	
			
		10~15 10~15 min	
		1 cycle	
			122222
6	Damp heat with	DC voltage 1.5 times as much as rated voltage shall be applied continuously between adjacent terminal at 60±2°C and 90~95%RH. After	Insulation resistance (50V DC) :
	load (Silver migration)	500 hours testing, switch shall be allowed to stand under normal	Voltage proof : Apply 100V AC for 1
		temperature and humidity condition for 1 hour, and measurement shall	minute. No dielectr breakdown shall occ
		be made within 1 hour after that. Vater drops shall be removed.	. Diearoowii Silaii occ
_	. Hechanical perform		
_	Items	Test conditions	Criterion
. 1	Preventive	A load of 20N{2.04ksf} shall be applied	2 keys shall not be locked
	strength of	between adjacent keys for 15 sec. as follows.	the same time.
	simultaneous		•
	locking		
	VApplied to the	Load .	
	switch with	-	
	Simultaneous	1 H H H	
	locking prevention		
	cam.	/	
	-		
			·
	recaution in use		
	Note that if the lo	ad is applied to the terminals during soldering they might suffer defor	mation and defects in electrical
1.	Note that if the loperformance.	ad is applied to the terminals during soldering they might suffer defor	
1. 2.	Note that if the loperformance. Use of water-solub	le soldering flux shall be avoided because it may cause corrosion of	the switch.
1. 2.	Note that if the loperformance. Use of water - solub The knob shoul	le soldering flux shall be avoided because it may cause corrosion of d be mounted or demounted after single-lock releasing	the switch.
1. 2.	Note that if the loperformance. Use of water-solub The knob shoul	le soldering flux shall be avoided because it may cause corrosion of	the switch. ism may be damaged.

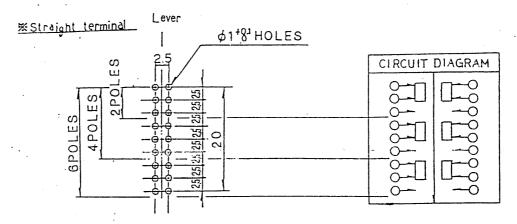
4.Flux flow

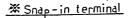
If too much flux is applied to the PCB it may penetrate into the switch and inhibit subsequent operation.

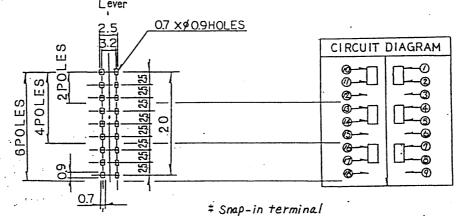


Flux may flow into the switch mount as indicated by

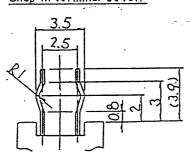
Printed circuit board mounting hole diagram . (± 0.05 tolerance unless otherwise specified)







Snap-in terminal detail



2 POLES: TERMINAL NO. (1) (2) (3) (1) (1) (4) POLES: TERMINAL NO. (2) (5) (1) (14)

6 POLES: TERMINAL NO. 258

					APPD.	CHIXD.	DSGD.	TITLE	
					11	0	Jan, 30'93		
					/,	A	1/1/ 1:	DRAWING NO.	,c ,c ,
PAGE SY	MB DATE	APPD	CHKD	DSGD	Kino	Tapakashi	+ yam gucuc		(2/2)

